

ACE1V2012

Automotive grade common-mode chip inductor



Product features

- AEC-Q200 qualified
- 0805 (2012 metric) package
- Impedance range from 90 ohms to 2200 ohms
- Moisture sensitivity level (MSL): 1

Applications

- Controller area network (CAN)
- Ethernet architectures
- Automotive signal line filter
- Advanced driver assistance systems (ADAS)
- Infotainment, safety cameras, sensors, xEV, Powertrain
- Engine control unit (ECU)
- Electric power steering system (EPS)
- Battery management systems (BMS)

Environmental compliance and general specifications

- Operating temperature range: -40 °C to +105 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant



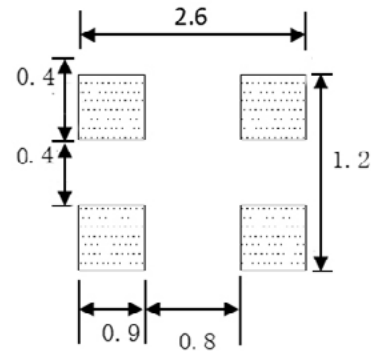
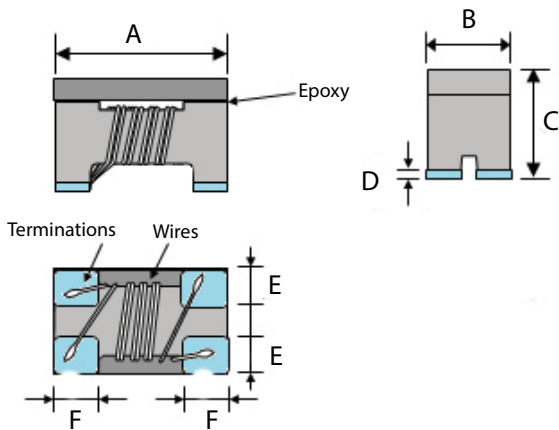
Product specifications

Part number	Common-mode impedance Z (Ω) at 100 MHz	DCR (Ω) @ +25 °C maximum	Idc (mA) maximum	Rated voltage (Vdc) typical	Insulation resistance (MΩ) minimum	Withstanding voltage (Vdc) typical
ACE1V2012-900-R	90 ±25%	0.3	400	50	10	125
ACE1V2012-121-R	120 ±25%	0.3	370	50	10	125
ACE1V2012-201-R	200 ±25%	0.35	330	50	10	125
ACE1V2012-361-R	360 ±25%	0.4	280	50	10	125
ACE1V2012-681-R	680 ±25%	0.8	220	50	10	125
ACE1V2012-102-R	1000 ±25%	1.5	190	50	10	125
ACE1V2012-222-R	2200 ±25%	2.0	150	50	10	125

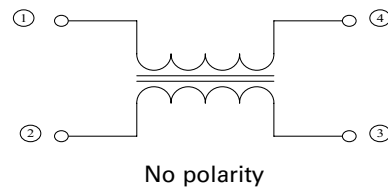
1. Part Number Definition: ACE1V2012-xxn-R
 ACE1V2012 = Product code and size
 xx= inductance value in ohms,
 n= multiplication factor: 10ⁿ (i.e. 900 = 90 * 10⁰ = 90 ohms)
 -R suffix = RoHS compliant

Mechanical parameters, schematic, pad layout (mm)

Recommended pad layout



Equivalent circuit

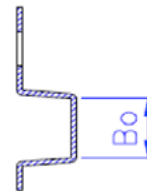
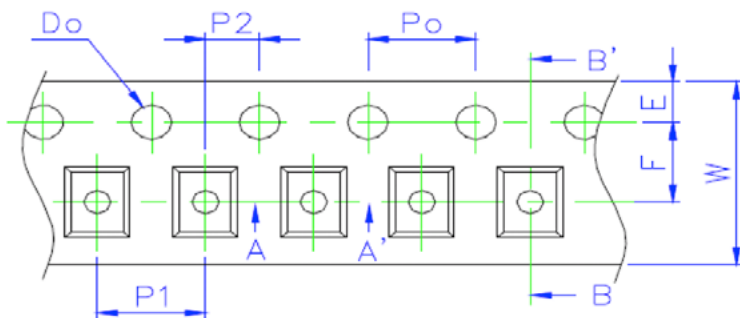


Part Number	A	B	C	D	E	F
ACE1V2012-xxn-R	2.0 ±0.2	1.2 ±0.2	1.2 ±0.2	0.2 ±0.1	0.40 typ	0.45 typ

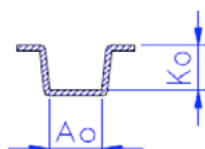
All soldering surfaces to be coplanar within 0.1 millimeters
 Tolerances are ±0.1 millimeters unless stated otherwise
 Pad layout dimensions are reference only
 Traces or vias underneath the inductor is not recommended

Packaging information (mm)

Supplied in tape and reel packaging, 2000 parts per 7" diameter reel



SEC: B-B'

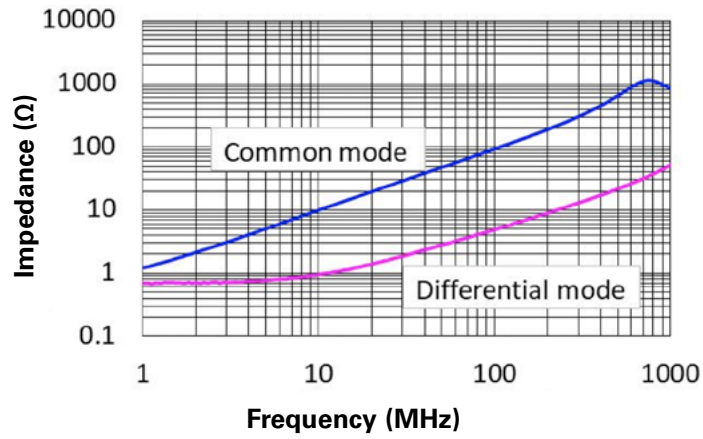


SEC: A-A'

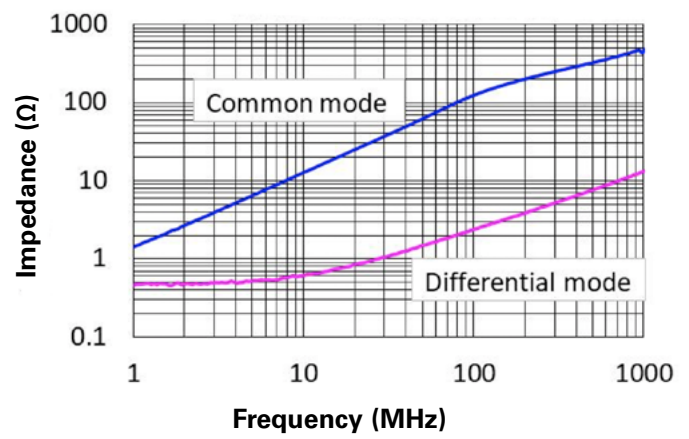
Ao	1.50±0.10
Bo	2.35±0.10
Ko	1.45±0.10
W	8.00±0.20
E	1.75±0.10
F	3.50±0.05
Po	4.0±0.05
P1	4.0±0.10
Do	1.0±0.1

Performance curves

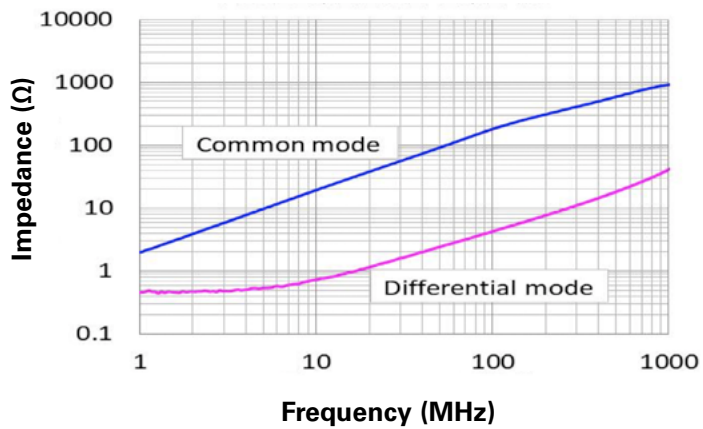
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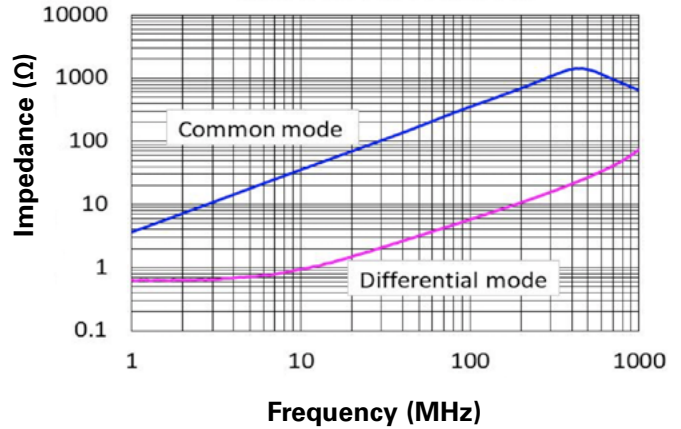
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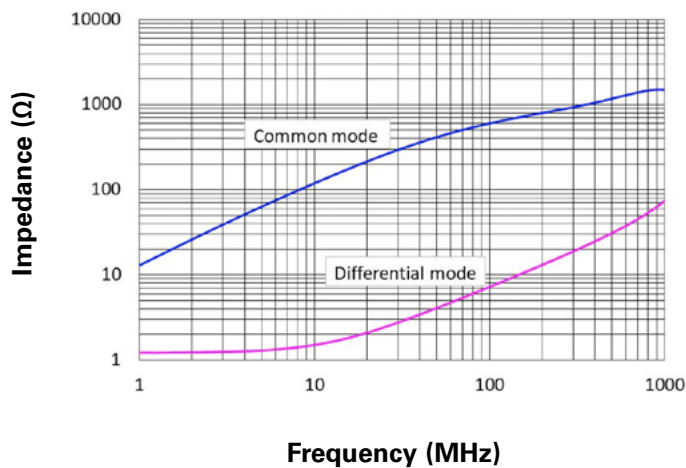
ACE1V2012-201-R



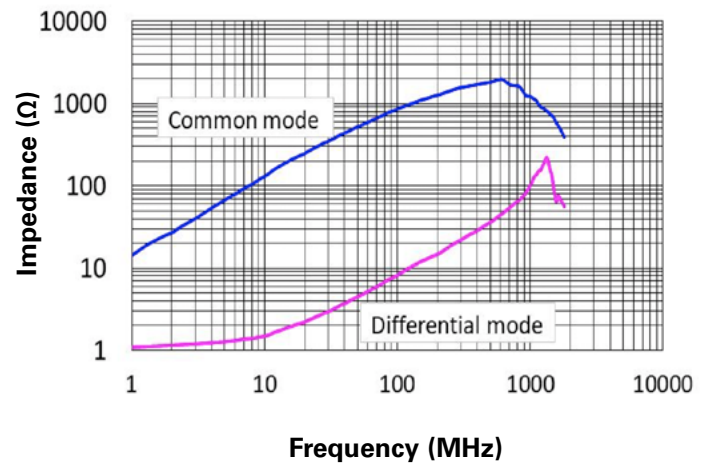
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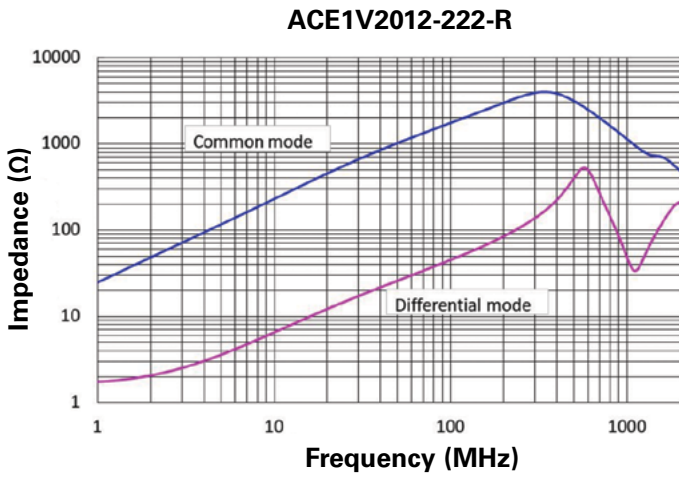
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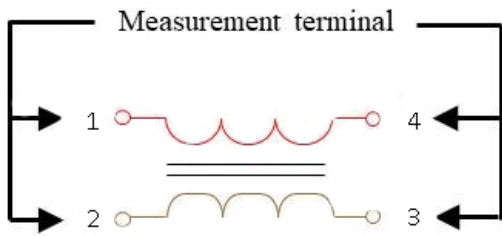
ACE1V2012-102-R



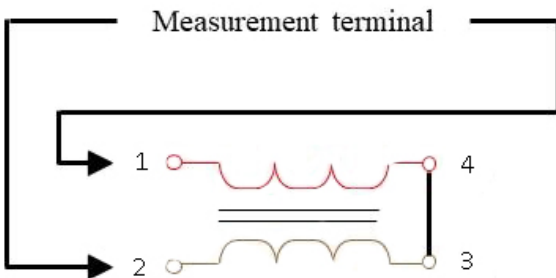
Performance curves



Common mode measurement method:



Differential mode measurement method:



Solder reflow profile

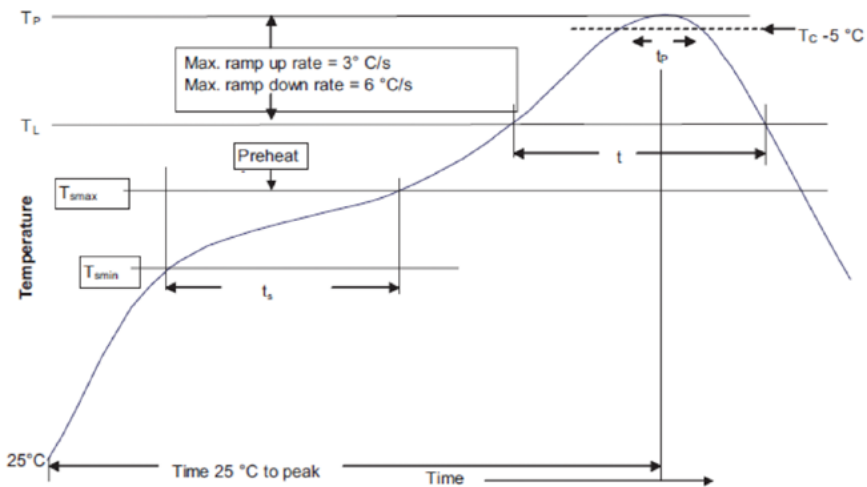


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_P	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time (t_L) maintained above T_L	60-150 seconds	60-150 seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_p)* within 5 °C of the specified classification temperature (T_C)	20 seconds*	30 seconds*
Ramp-down rate (T_P to T_L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

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 Printed in USA
 Publication No. 10984 BU-MC19112
 November 2019

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